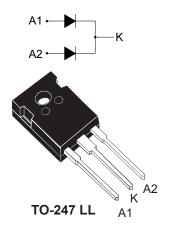


Automotive 170 V, dual 30 A lowdrop power Schottky rectifier



Features



- AEC-Q101 qualified
- Avalanche capability
- 175 °C maximum operating junction temperature
- V_{RRM} guaranteed from -40 °C to +175 °C
- PPAP capable
- ECOPACK2 compliant

Applications

- DC/DC converter
- · Freewheeling diodes
- LLC topology
- · Phase shift topology
- Electrical vehicles (EV) and Hybrid electrical vehicles

Description

The STPS61170C-Y has been developed for applications requiring a high-voltage secondary rectification diode, and in particular for DC/DC converters used in electrical cars.

| Product status |
|----------------|
| STPS61170C-Y |

| Product summary | | | | |
|----------------------|----------|--|--|--|
| I _{F(AV)} | 2 x 30 A | | | |
| V _{RRM} | 170 V | | | |
| T _{j(max.)} | 175 °C | | | |
| V _{F(typ.)} | 0.64 V | | | |



1 Characteristics

Table 1. Absolute ratings (limiting values per diode at 25 °C, unless otherwise specified)

| Symbol | Parameter | Value | Unit | | |
|---------------------|---|-------------------------|------------|------|----|
| V_{RRM} | Repetitive peak reverse voltage (T _j = -40 °C to +175 °C) | | | 170 | V |
| I _{F(RMS)} | Forward rms current | | | 80 | Α |
| | T _c = | | Per diode | 30 | |
| I _{F(AV)} | Average forward current, δ = 0.5, square wave | T _c = 160 °C | Per device | 60 | Α |
| I _{FSM} | Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$ | | | 500 | Α |
| P _{ARM} | Repetitive peak avalanche power $t_p = 10 \mu s$, $T_j = 125 °C$ | | | | W |
| T _{stg} | Storage temperature range | | | | °C |
| Tj | Maximum operating junction temperature ⁽¹⁾ | | | +175 | °C |

^{1.} $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameters

| Symbol | Parameter | | Typ. value | Unit |
|----------------------|------------------|-------|------------|------|
| Du Innetion to coop | Per diode | 0.34 | °C/W | |
| R _{th(j-c)} | Junction to case | Total | 0.17 | C/VV |

For more information, please refer to the following application note:

• AN5088 : Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics (per diode)

| Symbol | Parameter | Test conditions | | Min. | Тур. | Max. | Unit |
|--------------------------------|---|-------------------------|--|------|------|------|------|
| ı (1) | I _R ⁽¹⁾ Reverse leakage current | T _j = 25 °C | V _R = 170 V | - | | 60 | μA |
| IR (7 | | T _j = 125 °C | | - | 16 | 60 | mA |
| | | T _j = 25 °C | I _F = 30 A I _F = 60 A | - | | 0.84 | |
| V _F ⁽²⁾ | Convert veltage drep | T _j = 125 °C | | - | 0.64 | 0.69 | V |
| v _F · Folward volta | Forward voltage drop | T _j = 25 °C | | - | | 0.94 | V |
| | | T _j = 125 °C | | - | 0.76 | 0.81 | |

- 1. Pulse test: $t_p = 5$ ms, $\delta < 2\%$
- 2. Pulse test: t_p =380 μ s, δ < 2%

To evaluate the conduction losses, use the following equation: $P = 0.57 \times I_{F(AV)} + 0.004 \times I_{F}^{2}$ (RMS)

For more information, please refer to the following application notes related to the power losses :

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

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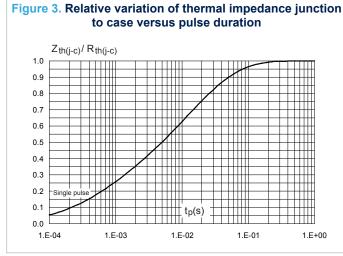
1.1 Characteristics (curves)

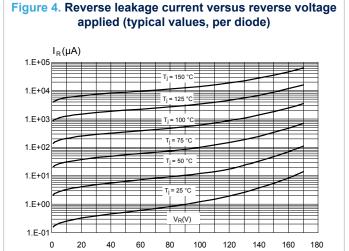
Figure 1. Average forward current versus case temperature (δ = 0.5, per diode) $I_{F(AV)}(A)$ T_c (°C)

Figure 2. Normalized avalanche power derating versus pulse duration (T_j= 125 °C)

P_{ARM}(tp)
P_{ARM}(10 µs)

1
0.01
0.001
1
100
1000





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Figure 5. Junction capacitance versus reverse voltage applied (typical values, per diode)

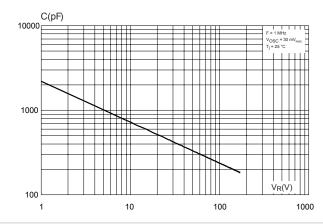
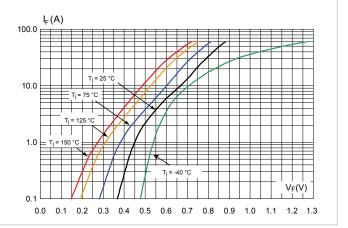


Figure 6. Forward voltage drop versus forward current (typical values, per diode)



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Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 TO-247 package_information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.8 to 1.0 N·m

HEAT-SINK PLANE

BACK VIEW

HEAT-SINK PLANE

BACK VIEW

Figure 7. TO-247 long leads package outline

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Table 4. TO-247 long leads package mechanical data

| Dim. | mm. | | | Inches | | |
|--------|-------|------|-------|--------|------|-------|
| Dilli. | Min. | Тур. | Max. | Min. | Тур. | Max. |
| Α | 4.90 | | 5.15 | 0.192 | | 0.203 |
| A1 | 2.25 | | 2.55 | 0.088 | | 0.101 |
| A2 | 1.85 | | 2.10 | 0.072 | | 0.083 |
| В | 1.07 | | 1.32 | 0.042 | | 0.052 |
| B2 | 2.87 | | 3.38 | 0.112 | | 0.134 |
| В3 | 1.90 | | 2.38 | 0.074 | | 0.094 |
| С | 0.55 | | 0.67 | 0.021 | | 0.027 |
| D | 20.82 | | 21.10 | 0.819 | | 0.831 |
| E | 15.70 | | 16.02 | 0.618 | | 0.631 |
| E2 | 4.90 | | 5.10 | 0.192 | | 0.201 |
| E3 | 2.40 | | 2.60 | 0.094 | | 0.103 |
| е | 5.34 | | 5.54 | 0.210 | | 0.219 |
| L | 19.80 | | 20.30 | 0.779 | | 0.800 |
| L1 | 4.16 | | 4.47 | 0.163 | | 0.176 |
| Р | 3.50 | | 3.70 | 0.137 | | 0.146 |
| Q | 5.49 | | 6.00 | 0.216 | | 0.237 |
| S | 6.04 | | 6.29 | 0.237 | | 0.248 |

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3 Ordering information

Table 5. Order code

| Order code | Marking | Package | Weight | Base qty. | Delivery mode |
|---------------|---------------|-----------|--------|-----------|---------------|
| STPS61170CWLY | STPS61170CWLY | TO-247 LL | 4.36 g | 30 | Tube |

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Revision history

Table 6. Document revision history

| Date | Revision | Changes |
|-------------|----------|--------------|
| 20-Nov-2019 | 1 | First issue. |

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